BL9161G

300mA Ultra-low Noise, Ultra-Fast CMOS LDO Regulator

FEATURES

- Ultra-low Noise
- Ultra-Fast Response in Line/Load Transient
- 0.01μA Standby Current When Shutdown
- Low Dropout: 205mV@300mA
- Wide Operating Voltage Ranges: 2.2V to 6V
- Low Temperature Coefficient
- Current Limiting Protection
- Thermal Shutdown Protection
- Only 1μF Output Capacitor Required for Stability
- High Power Supply Rejection Ratio
- Fast output discharge
- Available in SOT23-5 ，SOT23-3, SC70-5 and DFN1×1-4L Package

APPLICATIONS

- Cellular and Smart Phones
- Cordless Telephones
- Battery-Powered Equipment
- Laptop, Palmtops, Notebook Computers
- Hand-Held Instruments
- PCMCIA Cards
- MP3/MP4/MP5 Players
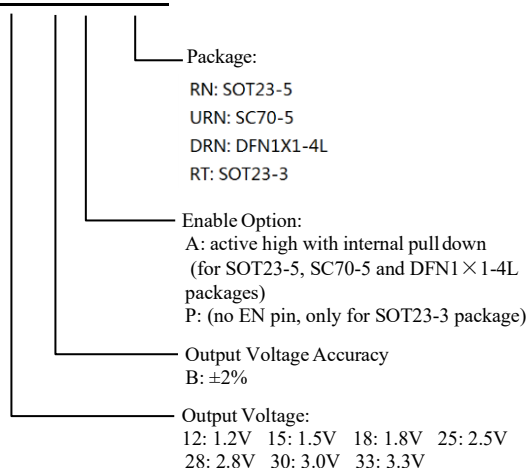- Portable Information Appliances

DESCRIPTION

The BL9161G is designed for portable applications with demanding performance and space requirements. The BL9161G performance is optimized for battery-powered systems to deliver ultra low noise and low quiescent current. Regulator ground current increases only slightly in dropout, further prolonging the battery life. The BL9161G also works with low-ESR ceramic capacitors, reducing the amount of board space necessary for power applications, critical in hand-held wireless devices. The BL9161G consumes only 0.01μA current in shutdown mode and has fast turn-on time (Typical 50μs). The other features include ultra low dropout voltage, high output accuracy, current limiting protection, and high ripple rejection ratio.

ORDERING INFORMATION
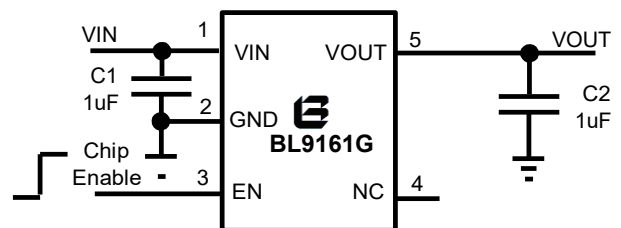
BL9161G XX X X XXX

Package:
RN: SOT23-5
URN: SC70-5
DRN: DFN1X1-4L
RT: SOT23-3

Enable Option:
A: active high with internal pull down (for SOT23-5, SC70-5 and DFN1×1-4L packages)
P: (no EN pin, only for SOT23-3 package)

Output Voltage Accuracy
B: ±2%

Output Voltage:
12: 1.2V   15: 1.5V   18: 1.8V   25: 2.5V
28: 2.8V   30: 3.0V   33: 3.3V

TYPICAL APPLICATION

**Application hints:**

Output capacitor (C2≥ 2.2uF) is recommended in BL9161G-1.2V，BL9161G-1.5V and BL9161G-1.8V application to assure the stability of circuit.

上海贝岭
SHANGHAI BELLING

Absolute Maximum Rating [Note 1]

Input Supply Voltage (VIN)	-0.3V to +6V
EN Pin Input Voltage	-0.3V to VIN
Output Voltages	-0.3V to VIN+0.3V
Output Current	300mA

Maximum Junction Temperature	150°C
Operating Temperature Range [Note2]	-40°C to 85°C
Storage Temperature Range	-65°C to 125°C
Lead Temperature (Soldering, 10s)	300°C

PIN CONFIGURATIONS

SOT23-5 &SC70-5(TOP VIEW)
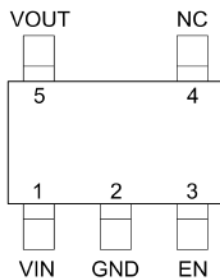
DFN1X1-4L(TOP VIEW)
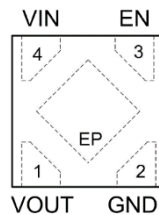
SOT23-3(TOP VIEW)
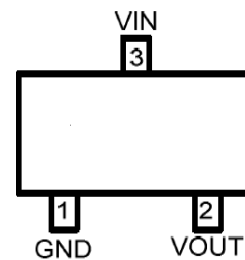
Package Marking

SOT23-5 & SC70-5   SOT23-3
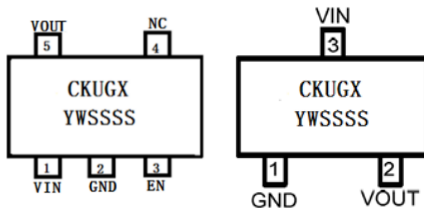
DFN1×1-4L

CKUG: Chip ID
X: Output voltage
Y: Data code—Year
W: Data code—Week

G：Chip ID
X：Output voltage
W：Data code—Week

Thermal Resistance [Note3]：

Package	Θ_{JA}	Θ_{JC}
SOT23-5	250℃/W	130℃/W
SC70-5	333℃/W	170℃/W

Output voltage	1.2V	1.5V	1.8V	2.5V	2.8V	3.0V	3.3V
X(SOT23-5, SOT23-3& SC70-5)	B	C	D	E	G	I	K
X(DFN1×1-4L)	B	C	D	E	G	I	K

Y	4	5	6	…	0	1	…
Year	2014	2015	2016	…	2020	2021	…

W	A	…	Y	Z	a	…	y	z
Week	1	…	25	26	27	…	51	52

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.
Note 2: The BL9161G is guaranteed to meet performance specifications from 0°C to 70°C. Specifications over the –40°C to 85°C operating temperature range are assured by design, characterization and correlation withstatistical process controls.
Note 3: Thermal Resistance is specified with approximately 1 square of 1 ozcopper.

Pin Description

SOT23-5 , SC70-5 & SOT23-3

PIN		NAME	FUNCTION
SOT23-5 &SC70-5	SOT23-3		
1	3	VIN	Power Input Voltage.
2	1	GND	Ground.
3		EN	Chip Enable Pin, This pin has an internal pull-down resistor
4		NC	No Connection.
5	2	VOUT	Output Voltage.

DFN1X1-4L

PIN	NAME	FUNCTION
1	VOUT	Output Voltage.
2	GND	Ground.
3	EN	Chip Enable Pin, This pin has an internal pull-down resistor
4	VIN	Power Input Voltage.
Exposed Pad		The exposed pad should be connected to a large ground plane to maximize thermal performance.

Block Diagram
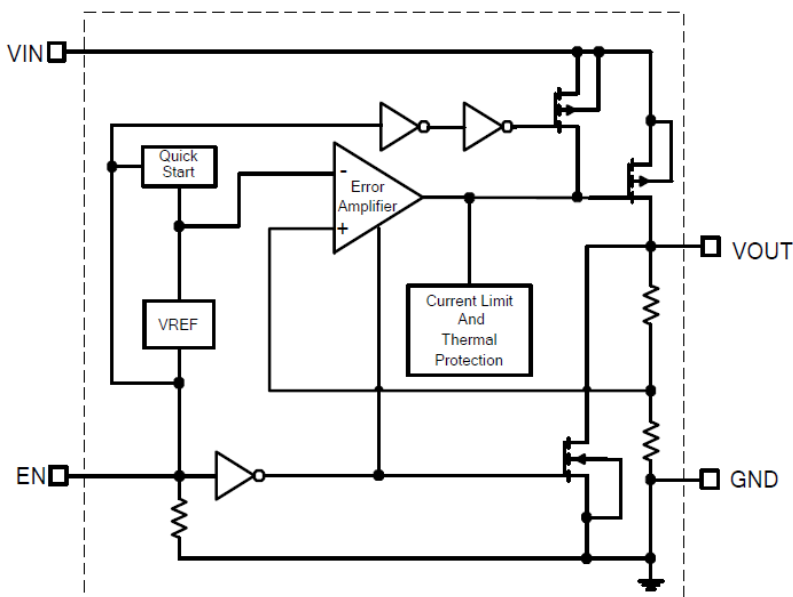
Electrical Characteristics (Note 4)

(V_{IN}=Vout +1V, EN=V_{IN}, C_{IN}=C_{OUT}=1μF, T_A=25℃, unless otherwise noted.)

Parameter		Symbol	Conditions	MIN	TYP	MAX	unit
Input Voltage		V_{IN}		2.2		6	V
Output Voltage Accuracy		ΔV_{OUT}	V_{IN}=Vout+1V, I_{OUT}=1mA	-2		+2	%
Current Limit		I_{LIM}	R_{LOAD}=1Ω	360	450		mA
Quiescent Current		I_Q	V_{EN}>1.2V, I_{OUT}=0mA		70	110	μA
Dropout Voltage		V_{DROP}	I_{OUT}=200mA, V_{OUT}=3.3V		135	200	mV
			I_{OUT}=300mA, V_{OUT}=3.3V		205	300	
			I_{OUT}=200mA, V_{OUT}=2.8V		150	225	
			I_{OUT}=300mA, V_{OUT}=2.8V		230	345	
			I_{OUT}=200mA, V_{OUT}=1.8V		230	345	
			I_{OUT}=300mA, V_{OUT}=1.8V		340	510	
Line Regulation(Note 5)		ΔV_{LINE}	V_{IN}=Vout+1V to 5.5V I_{OUT}=1mA		0.02	0.17	%/V
Load Regulation(Note6)		ΔV_{LOAD}	1mA<I_{OUT}<300mA		20		mV
Output Voltage(Note 7) Temperature Coefficient		TC_{VOUT}	I_{OUT}=1mA		±60		ppm/℃
Standby Current		I_{STBY}	V_{EN}=GND, Shutdown		0.01	1	μA
EN Input Bias Current		I_{IBSD}	V_{EN}=GND or V_{IN}			2	μA
EN Input Threshold	Logic Low	V_{IL}	V_{IN}=3V to 5.5V, Shutdown			0.4	V
	Logic High	V_{IH}	V_{IN}=3V to 5.5V, Start up	1.2			V
Output Noise Voltage		e_{NO}	10Hz to100KHz, I_{OUT}=100mA		180		μV_{RMS}
Power Supply Rejection Ratio	f=217Hz	PSRR	I_{OUT}=10mA		-75		dB
	f=1KHz				-71		
	f=10KHz				-55		
Thermal Shutdown Temperature		T_{SD}	Shutdown, Temp increasing		170		℃
Thermal Shutdown Hysteresis		T_{SDHY}			30		℃

Note 4: Production test at +25°C. Specifications over the temperature range are guaranteed by design and characterization.

Note 5: Line regulation is calculated by $\Delta V_{LINE} = \left| \left(\dfrac{V_{OUT1} - V_{OUT2}}{\Delta V_{IN} \times V_{OUT(normal)}} \right) \right| \times 100$

Where V_{OUT1} is the output voltage when V_{IN}=5.5V, and V_{OUT2} is the output voltage when V_{IN}=4.3V,
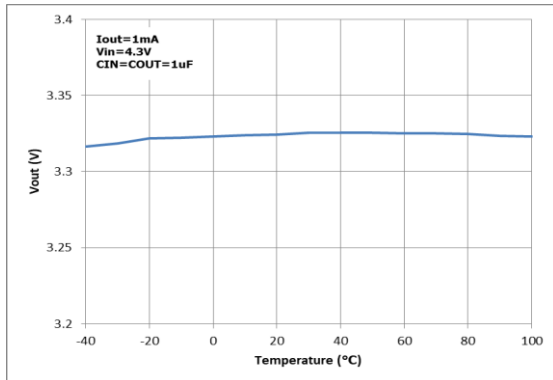
ΔV_{IN}=1.2V. V_{OUT} (normal) =3.3V.

Note 6: Load regulation is calculated by V_{load}=Vout1-Vout2
Where V_{OUT1} is the output voltage when I_{OUT}=1mA, and V_{OUT2} is the output voltage when I_{OUT}=300mA.

Note 7: The temperature coefficient is calculated by $TC_{V_{OUT}} = \dfrac{\Delta V_{OUT}}{\Delta T \times V_{OUT}}$

Typical Performance Characteristics

Output Voltage Vs. Temperature

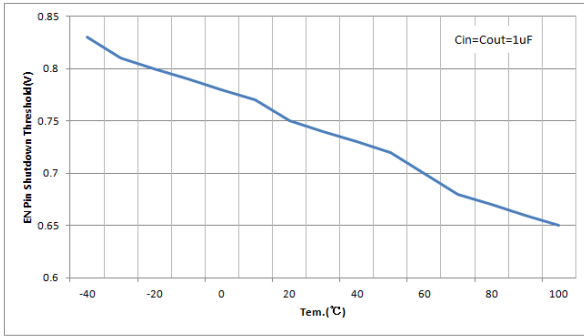### Quiescent Current Vs. Temperature
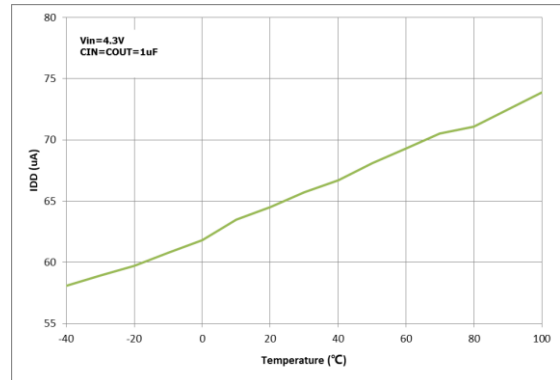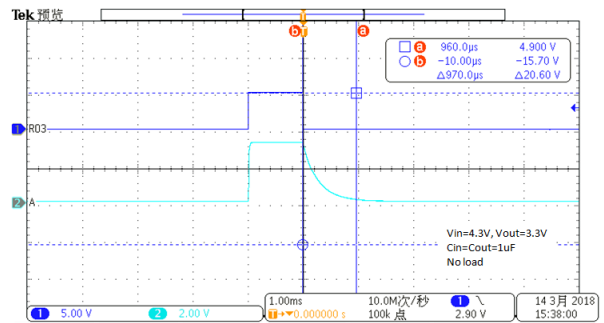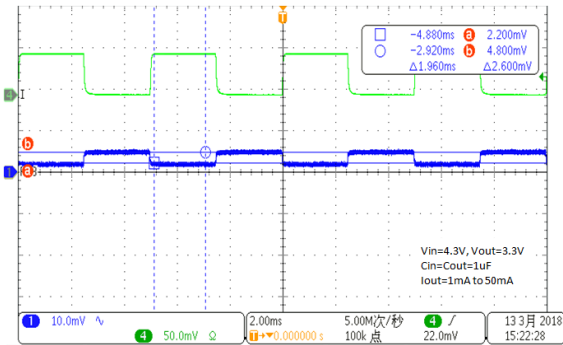

Dropout Voltage Vs. Load Current
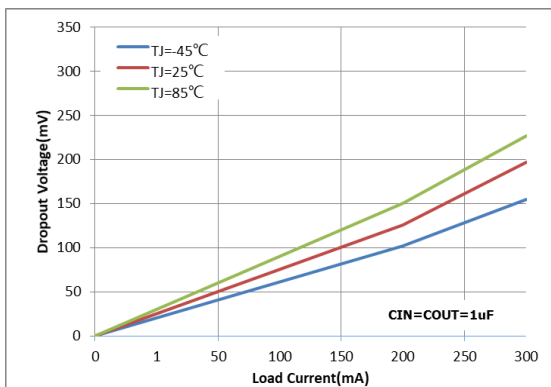
PSRR
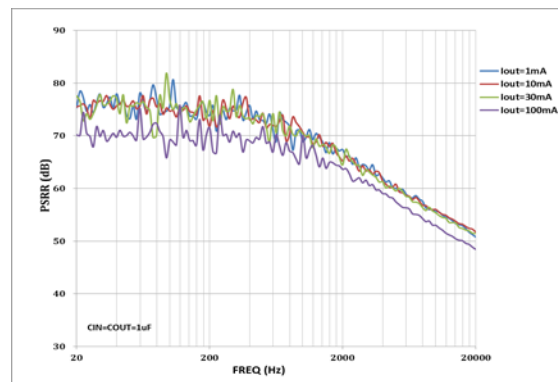
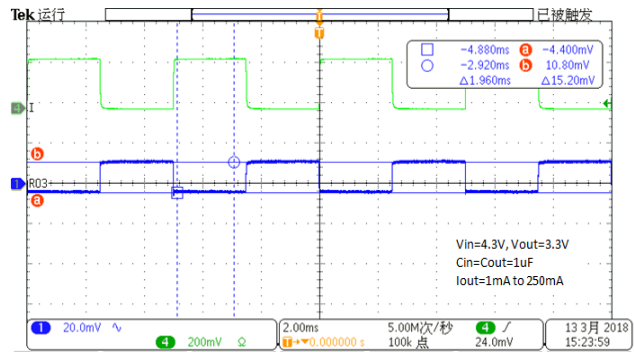**EN Pin Shutdown Threshold Vs. Temperature**
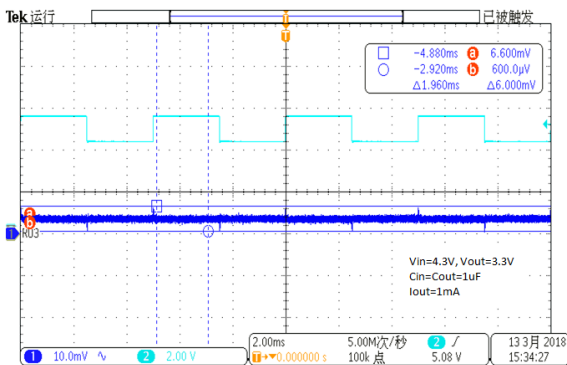

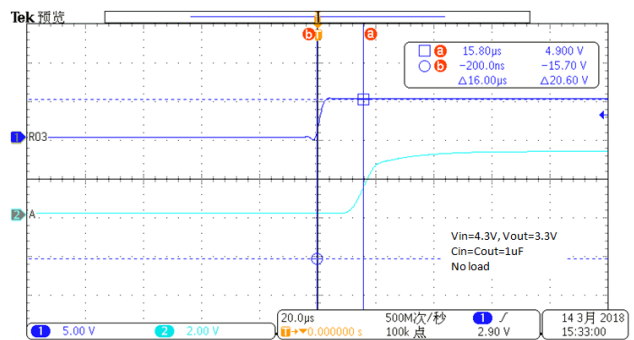**EN Pin Shutdown Response**

Load Transient Response

Load Transient Response

Line transient Response

Start up

Applications Information

Like any low-dropout regulator, the external capacitors used with the BL9161G must be carefully selected for regulator stability and performance. Using a capacitor whose value is > 1µF on the BL9161G input and the amount of capacitance can be increased without limit. The input capacitor must be located a distance of not more than 0.5 inch from the input pin of the IC and returned to a clean analog ground. Any good quality ceramic or tantalum can be used for this capacitor. The capacitor with larger value and lower ESR (equivalent series resistance) provides better PSRR and line-transient response. The output capacitor must meet both requirements for minimum amount of capacitance and ESR in all LDOs application. The BL9161G is designed specifically to work with low ESR ceramic output capacitor in space-saving and performance consideration. Using a ceramic capacitor whose value is at least 1µF with ESR is > 25mΩ on the BL9161G output ensures stability. The BL9161G still works well with output capacitor of other types due to the wide stable ESR range. Output capacitor of larger capacitance can reduce noise and improve load transient response, stability, and PSRR. The output capacitor should be located not more than 0.5 inch from the V_{OUT} pin of the BL9161G and returned to a clean analog ground.

Enable Function

The BL9161G features an LDO regulator enable/disable function. To assure the LDO regulator will switch on; the EN turn on control level must be greater than 1.2 volts. The LDO regulator will go into the shut-down mode when the voltage on the EN pin falls below 0.4 volts. For to protect the system, the BL9161G have a quick discharge function. If the enable function is not needed in a specific application, it may be tied to V_{IN} to keep the LDO regulator in a continuously on state.

Thermal Considerations

Thermal protection limits power dissipation in BL9161G. When the operation junction temperature exceeds 170°C, the OTP circuit starts the thermal shutdown function turn the pass element off. The pass element turns on again after the junction temperature cools by 30°C.

For continue operation, do not exceed absolute maximum operation junction temperature 125°C. The power dissipation definition in device is:

$$P_D(MAX) = (T_J(MAX) − T_A)/\theta_{JA}$$

Where $T_J(MAX)$ is the maximum operation junction temperature 125°C, T_A is the ambient temperature and the θ_{JA} is the junction to ambient thermal resistance. For recommended operating conditions specification of BL9161G, where $T_J(MAX)$ is the maximum junction temperature of the die (125°C) and T_A is the maximum ambient temperature. The junction to ambient thermal resistance (θ_{JA} is layout dependent) for SOT-23-5 package is 250°C/W, on standard JEDEC 51-3 thermal test board. The maximum power dissipation at T_A= 25°C can be calculated by following formula:

$P_D(MAX) = (125°C-25°C)/250 = 400mW$ (SOT-23-5)

The maximum power dissipation depends on operating ambient temperature for fixed $T_J(MAX)$ and thermal resistance θ_{JA}. It is also useful to calculate the junction of temperature of the BL9161G under a set of specific conditions. In this example let the Input voltage V_{IN}=3.3V, the output current Io=300mA and the case temperature T_A=40°C measured by a thermal couple during operation. The power dissipation for the V_{OUT}=2.8V version of the BL9161G can be calculated as:

$P_D = (3.3V-2.8V) \times 300mA + 3.6V \times 100uA$
    $=150mW$

And the junction temperature, T_J, can be calculated as follows:

$T_J = T_A + P_D \times \theta_{JA} = 40°C + 0.15W \times 250°C/W$
    $= 40°C + 37.5°C = 77.5°C < T_J(MAX) = 125°C$

For this operating condition, T_J is lower than the absolute maximum operating junction temperature,125°C, so it is safe to use the BL9161G in this configuration.
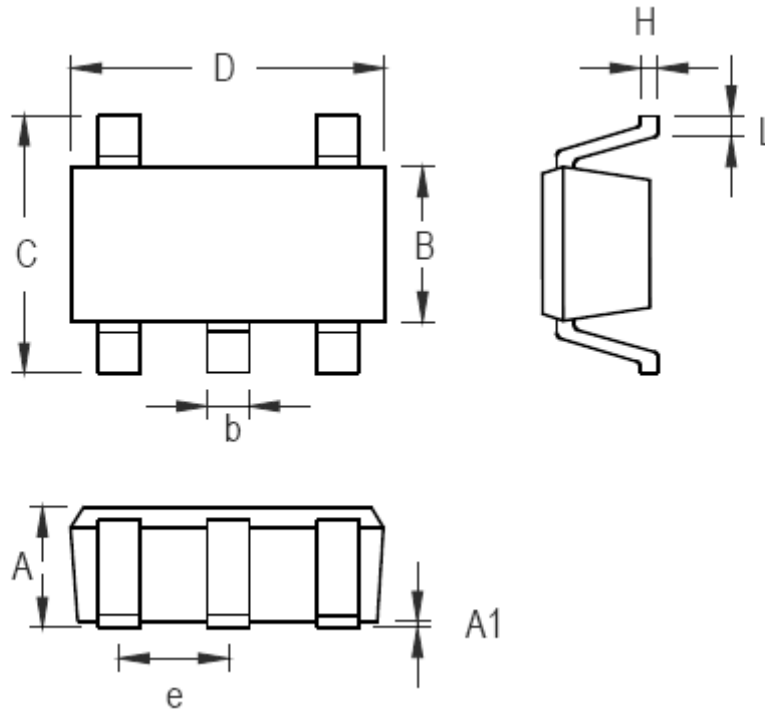
Layout considerations

To improve ac performance such as PSRR, output noise, and transient response, it is recommended that the PCB be designed with separate ground planes for V_{IN} and V_{OUT}, with each ground plane connected only at the GND pin of the device.
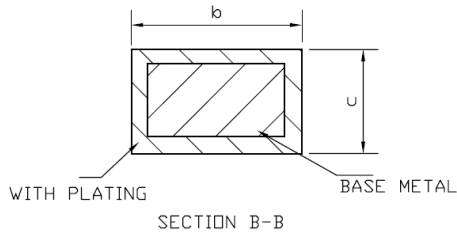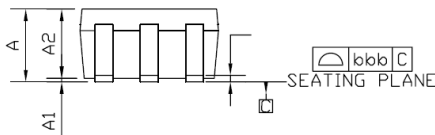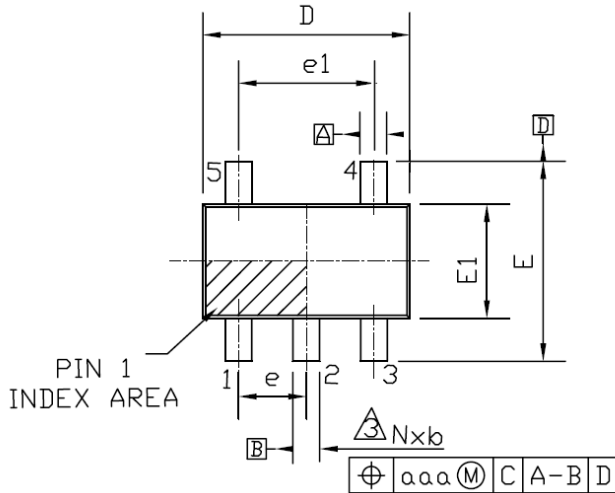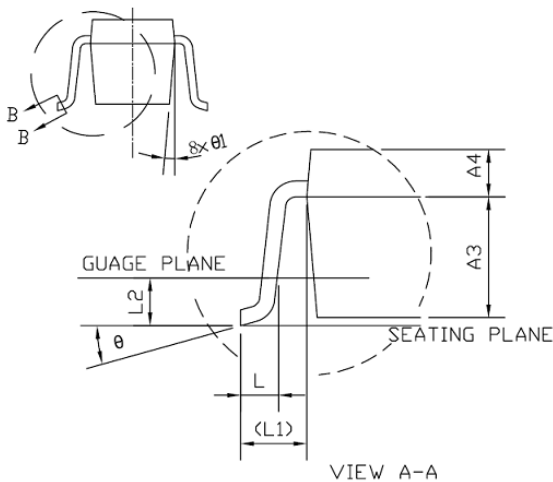
Package Description

SOT23-5

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.889	1.295	0.035	0.051
A1	0.000	0.152	0.000	0.006
B	1.397	1.803	0.055	0.071
b	0.356	0.559	0.014	0.022
C	2.591	2.997	0.102	0.118
D	2.692	3.099	0.106	0.122
e	0.838	1.041	0.033	0.041
H	0.080	0.254	0.003	0.010
L	0.300	0.610	0.012	0.024

SC70-5

COMMON DIMENSION			
SYMBOL	IN MILLIMETERS		
	MIN	NOMAL	MAX
A	0.80	–	1.10
A1	0	–	0.10
A2	0.80	0.90	1.00
A3	0.47	0.52	0.57
A4	0.33	0.38	0.43
b	0.15	–	0.30
c	0.10	–	0.25
D	1.85	2.00	2.20
e	0.65 BSC		
e1	1.30 BSC		
E	1.80	2.10	2.40
E1	1.15	1.25	1.35
L	0.10	–	0.45
L1	0.42 REF.		
L2	0.20 BSC		
θ	0°	4°	30°
θ1	4°	–	12°
aaa	0.10		
bbb	0.10		

DFN1×1-4L
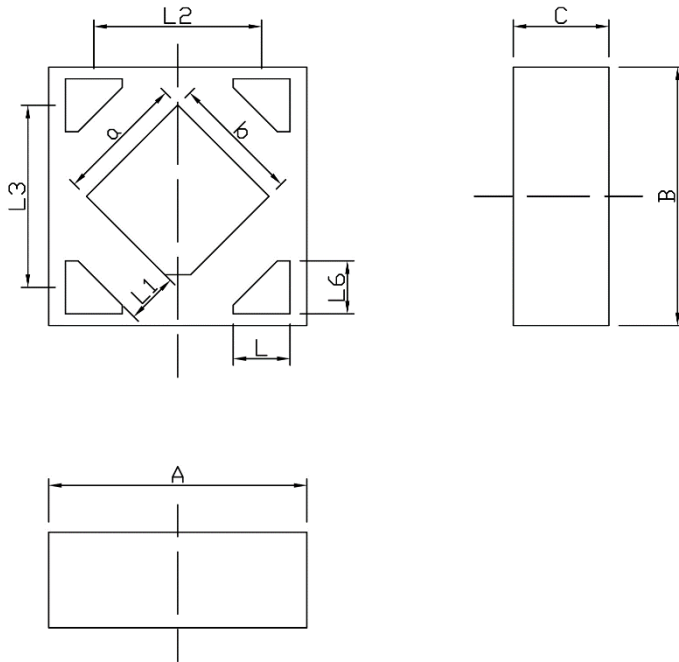
Dimensions In Millimeterer			
Symbol	MIN	TYP	MAX
A	0.950	1.000	1.050
B	0.950	1.000	1.050
C	0.320	0.370	0.420
L	0.170	0.220	0.270
L1	0.140	0.190	0.240
L2	0.600	0.650	0.700
L3	0.625	0.675	0.725
L6	0.175	0.225	0.275
a	0.440	0.490	0.540
b	0.440	0.490	0.540

There may be slight differences in shape
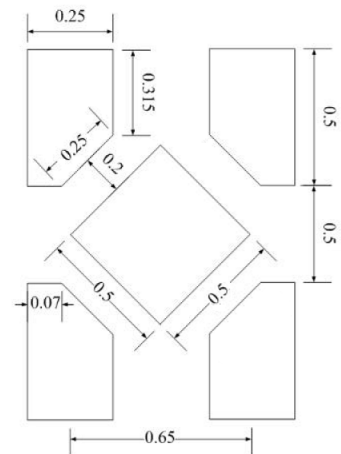
RECOMMENDED LAND PATTERN (Unit: mm)

SOT23-3